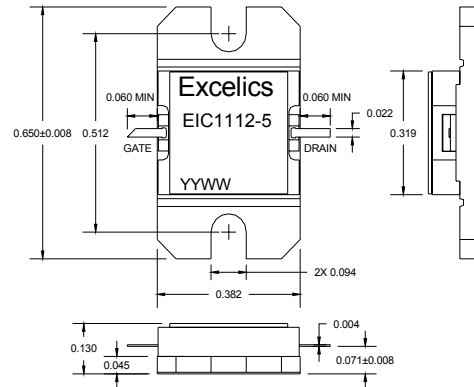


ISSUED 07/03/2007

## 11.7-12.7 GHz 5-Watt Internally Matched Power FET

### FEATURES

- 11.7– 12.7GHz Bandwidth
- Input/Output Impedance Matched to 50 Ohms
- +37.5 dBm Output Power at 1dB Compression
- 6.5 dB Power Gain at 1dB Compression
- 25% Power Added Efficiency
- Hermetic Metal Flange Package


**Caution! ESD sensitive device.**

### ELECTRICAL CHARACTERISTICS ( $T_a = 25^\circ\text{C}$ )

SYMBOL	PARAMETERS/TEST CONDITIONS <sup>1</sup>	MIN	TYP	MAX	UNITS
$P_{1dB}$	Output Power at 1dB Compression $f = 11.7-12.7\text{GHz}$ $V_{DS} = 10\text{ V}, I_{DSQ} \approx 1600\text{mA}$	36.5	37.5		dBm
$G_{1dB}$	Gain at 1dB Compression $f = 11.7-12.7\text{GHz}$ $V_{DS} = 10\text{ V}, I_{DSQ} \approx 1600\text{mA}$	5.5	6.5		dB
$\Delta G$	Gain Flatness $f = 11.7-12.7\text{GHz}$ $V_{DS} = 10\text{ V}, I_{DSQ} \approx 1600\text{mA}$			$\pm 0.6$	dB
PAE	Power Added Efficiency at 1dB Compression $V_{DS} = 10\text{ V}, I_{DSQ} \approx 1600\text{mA}$ $f = 11.7-12.7\text{GHz}$		25		%
$I_{d1dB}$	Drain Current at 1dB Compression $f = 11.7-12.7\text{GHz}$		1700	2000	mA
IM3	Output 3rd Order Intermodulation Distortion $\Delta f = 10\text{MHz}$ 2-Tone Test. $P_{out} = 26.5\text{ dBm S.C.L}$ $V_{DS} = 10\text{ V}, I_{DSQ} \approx 65\% I_{DSS}$ $f = 12.7\text{GHz}$	-40	-43		dBc
$I_{DSS}$	Saturated Drain Current $V_{DS} = 3\text{ V}, V_{GS} = 0\text{ V}$		2800	3500	mA
$V_P$	Pinch-off Voltage $V_{DS} = 3\text{ V}, I_{DS} = 24\text{ mA}$		-2.5	-4.0	V
$R_{TH}$	Thermal Resistance <sup>3</sup>		5.0	5.5	$^\circ\text{C/W}$

Note: 1) Tested with 100 Ohm gate resistor.

2) S.C.L. = Single Carrier Level.

 3) Overall  $R_{th}$  depends on case mounting.

### ABSOLUTE MAXIMUM RATING<sup>1,2</sup>

SYMBOLS	PARAMETERS	ABSOLUTE <sup>1</sup>	CONTINUOUS <sup>2</sup>
$V_{ds}$	Drain-Source Voltage	15	10V
$V_{gs}$	Gate-Source Voltage	-5	-4V
$I_{gsf}$	Forward Gate Current	61.2mA	20.4mA
$I_{gsr}$	Reserve Gate Current	-10.2mA	-3.4mA
$P_{in}$	Input Power	35.5dBm	@ 3dB Compression
$T_{ch}$	Channel Temperature	175 $^\circ\text{C}$	175 $^\circ\text{C}$
$T_{stg}$	Storage Temperature	-65 to +175 $^\circ\text{C}$	-65 to +175 $^\circ\text{C}$
$P_t$	Total Power Dissipation	27W	27W

Note: 1. Exceeding any of the above ratings may result in permanent damage.

2. Exceeding any of the above ratings may reduce MTTF below design goals.

Specifications are subject to change without notice.

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# EIC1112-5

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## 11.7-12.7 GHz 5-Watt Internally Matched Power FET

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness

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